

1200V, 85A, $V_{ce(on)} = 2.5V$ Typical

Ultra Fast NPT - IGBT®

The Ultra Fast NPT - IGBT® is a new generation of high voltage power IGBTs. Using Non-Punch-Through Technology, the Ultra Fast NPT-IGBT® offers superior ruggedness and ultrafast switching speed.

TO-247 Max TO-264

Features

- Low Saturation Voltage
- Low Tail Current
- RoHS Compliant

- Short Circuit Withstand Rated
- High Frequency Switching
- Ultra Low Leakage Current

Unless stated otherwise, Microsemi discrete IGBTs contain a single IGBT die. This device is recommended for applications such as induction heating (IH), motor control, general purpose inverters and uninterruptible power supplies (UPS).



MAXIMUM RATINGS

All Ratings:	$T_C = 25^{\circ}C$	unless	otherwise	specified.
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Symbol	Parameter	Ratings	Unit
V _{ces}	Collector Emitter Voltage	1200	V
V_{GE}	Gate-Emitter Voltage	±30	l v
I _{C1}	Continuous Collector Current @ T _C = 25°C	170	
I _{C2}	Continuous Collector Current @ T _C = 100°C	85	Α
I _{CM}	Pulsed Collector Current ①	340	
SCWT	Short Circuit Withstand Time: V _{CE} = 600V, V _{GE} = 15V, T _C =125°C	10	μs
P _D	Total Power Dissipation @ T _c = 25°C	962	W
T_{J},T_{STG}	Operating and Storage Junction Temperature Range	-55 to 150	°C
T _L	Max. Lead Temp. for Soldering: 0.063" from Case for 10 Sec.	300	°C

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Min	Тур	Max	Unit
V _{(BR)CES}	Collector-Emitter Breakdown Voltage (V _{GE} = 0V, I _C = 1.0mA)	1200			
$V_{\text{GE(TH)}}$	Gate Threshold Voltage $(V_{CE} = V_{GE}, I_{C} = 2.5 \text{mA}, T_{j} = 25 ^{\circ}\text{C})$	3.5	5.0	6.5	\ / - I4 -
.,	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 85A, T _j = 25°C)		2.5	3.2	Volts
$V_{CE(ON)}$	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 85A, T _j = 125°C)		3.3		
	Collector-Emitter On Voltage (V _{GE} = 15V, I _C = 170A, T _j = 25°C)		3.5		
I _{CES}	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 25°C) ②		10	1000	μA
CES	Collector Cut-off Current (V _{CE} = 1200V, V _{GE} = 0V, T _j = 125°C) (2)		100		
I _{GES}	Gate-Emitter Leakage Current (V _{GE} = ±20V)			±250	nA

CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

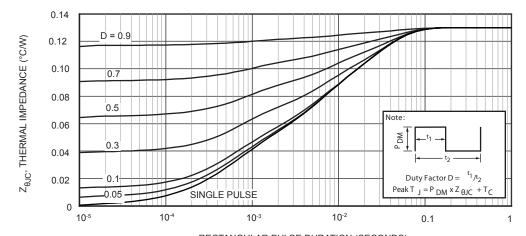
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit	
C _{ies}	Input Capacitance	Capacitance		8400			
C _{oes}	Output Capacitance	$V_{GE} = 0V, V_{CE} = 25V$		725		pF	
C _{res}	Reverse Transfer Capacitance	f = 1MHz		190			
V _{GEP}	Gate to Emitter Plateau Voltage	Cata Charas		7.5		V	
Q ³	Total Gate Charge	Gate Charge		490	660		
Q_{ge}	Gate-Emitter Charge	V _{GE} = 15V		60	85	0	
Q_{gc}	Gate- Collector Charge	$V_{CE} = 600V$ $I_{C} = 85A$		230	320	nC	
t _{d(on)}	Turn-On Delay Time	Inductive Switching (25°C)		43			
t _r	Current Rise Time	V _{cc} = 600V		70		20	
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		300		ns	
t _f	Current Fall Time	I _C = 85A		85			
E _{on2} 5	Turn-On Switching Energy	$R_{_{\rm G}} = 4.3 \Omega^{(4)}$		6000	9000	1	
E _{off}	Turn-Off Switching Energy	T _J = +25°C		3800	5700	μJ	
t _{d(on)}	Turn-On Delay Time	Inductive Switching (125°C)		43			
t,	Current Rise Time	V _{CC} = 600V		70			
t _{d(off)}	Turn-Off Delay Time	V _{GE} = 15V		350		ns	
t _f	Current Fall Time	I _C = 85A		95			
E _{on2}	Turn-On Switching Energy	$R_{\rm G} = 4.3 \Omega^{(4)}$		7800	11,700	1	
E _{off}	Turn-Off Switching Energy	T _J = +125°C		4900	7350	μJ	

THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Ol Characteristic		Min	Тур	Max	Unit
$R_{\theta JC}$	Junction to Case Thermal Resistance (IGBT)				.13	°C/W
$R_{\theta JA}$	Junction to Ambient Thermal Resistance				40	C/VV
W _T		B2		.22		oz
	Package Weight	DZ		6		g
	rackage vveignit			.36		oz
		L		10		g

- 1 Repetitive Rating: Pulse width and case temperature limited by maximum junction temperature.
- 2 Pulse test: Pulse Width < $380\mu s$, duty cycle < 2%.
- 3 See Mil-Std-750 Method 3471.
- 4 $R_{\rm g}$ is external gate resistance, not including internal gate resistance or gate driver impedance. (MIC4452)
- 5 E_{on2} is the clamped inductive turn on energy that includes a commutating diode reverse recovery current in the IGBT turn on energy loss. A combi device is used for the clamping diode.
- 6 E_{off} is the clamped inductive turn-off energy measured in accordance with JEDEC standard JESD24-1.

Microsemi reserves the right to change, without notice, the specifications and information contained herein.



RECTANGULAR PULSE DURATION (SECONDS)
Figure 1, Maximum Effective Transient Thermal Impedance, Junction-To-Case vs Pulse Duration

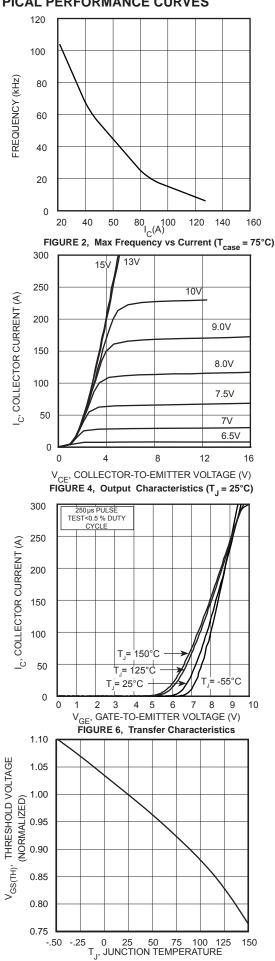


FIGURE 8, Threshold Voltage vs Junction Temperature

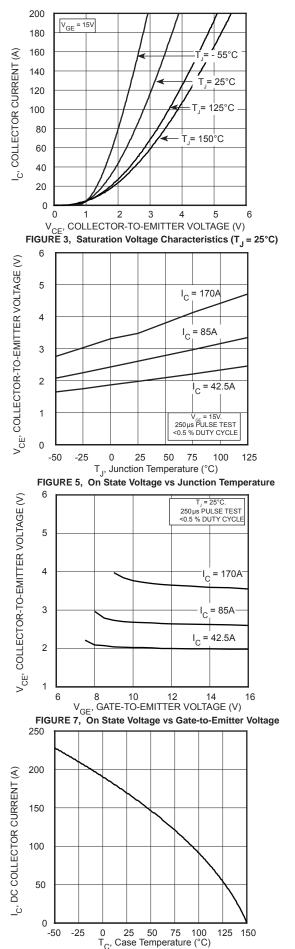
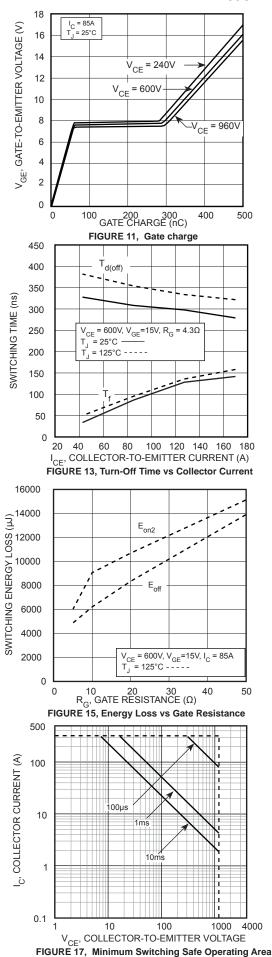


FIGURE 9, DC Collector Current vs Case Temperature

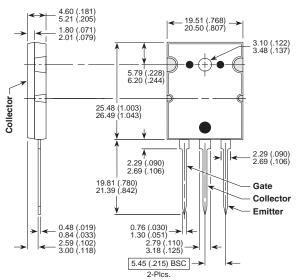
FIGURE 16, Swiitching Energy vs Junction Temperature



T-MAX™ (B2) Package Outline

These dimensions are equal to the TO-247 without the mounting hole. Dimensions in Millimeters and (Inches)

TO-264 (L) Package Outline



Dimensions in Millimeters and (Inches)

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